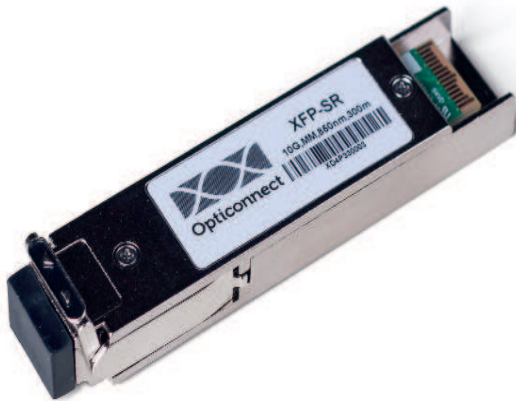


XFP-SR

XFP Dual Fiber Single-Mode Transceiver for 10GbE/10GFC/SDH/ SONET



Product Description

The XFP-SR is a multi-purpose optical transceiver module for 10Gbit/s data transmission applications at 850nm. It is ideally suited for 10 GbE datacom (belly-to-belly for high density applications) and storage area network(SAN/NAS) applications based on the IEEE 802.3ae and Fibre Channel standards. Designed for short range distances, the transceiver module comprises a transmitter with a vertical cavity surface emitting laser (VCSEL) and a receiver with a PIN photodiode. Transmitter and receiver are separate within a wide temperature range and offers optimum heat dissipation and excellent electromagnetic shielding thus enabling high port densities for 10 GbE systems.

Features

- 10 Gbit/s Bit Rate
- Distance 300 m
- Built-in Digital Diagnostics

Applications

- OC192/ STM 64
- 10GBASE-ZR/ZW 10G Ethernet
- 1200-SM-LL-L 10G Fiber Channel

For more information please contact:



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Opticonnect SYSTEMS B.V., an Optical Networking vendor with its headquarters in the Netherlands, provides Optical Transport solutions and Optical Transceivers at the best price performance ratio possible. Our goal is to simplify the planning, deployment and maintenance of

complex Optical Networks. This is achieved by our user friendly planning apps and information, sophisticated products and transparent support. Relying on our superior product quality, all items are supplied with life time warranty.

Ordering information:

Product code	Product description
XFP-SR	XFP Module, 10Gbps 10 Gigabit Ethernet, Fibre Channel 10 Gbps, 850 nm, LC Connector, 300m Distance/Budget, with Digital Diagnostics

Regulatory Compliance

Feature	Standard	Performance
Electrostatic Discharge (ESD) to the Electrical Pins	MIL-STD-883G Method 3015.7	Class 1C (>1000 V)
Electrostatic Discharge to the enclosure	EN 55024:1998+A1+A2 IEC-61000-4-2 GR-1089-CORE	Compatible with standards
Electromagnetic Interference (EMI)	FCC Part 15 Class B EN55022:2006 CISPR 22B :2006 VCCI Class B	Compatible with standards Noise frequency range: 30 MHz to 6 GHz. Good system EMI design practice required to achieve Class B margins. System margins are dependent on customer host board and chassis design.
Immunity	EN 55024:1998+A1+A2 IEC 61000-4-3	Compatible with standards. 1kHz sine-wave, 80% AM, from 80 MHz to 1 GHz. No effect on transmitter/receiver performance is detectable between these limits.
Laser Eye Safety	FDA 21CFR 1040.10 and 1040.11 EN (IEC) 60825-1:2007 EN (IEC) 60825-2:2004+A1	CDRH compliant and Class I laser product. TüV Certificate No. 50135086
Component Recognition	UL and CUL EN60950-1:2006	UL file E317337 TüV Certificate No. 50135086 (CB scheme)
RoHS6	2002/95/EC 4.1&4.2 2005/747/EC 5&7&13	Compliant with standards*note1

Note1: For update of the equipments and strict control of raw materials, Opticonnect has the ability to supply the customized products since Jan 1th, 2007, which meet the requirements of RoHS6 (Restrictions on use of certain Hazardous Substances) of European Union.

In light of item 5 in RoHS exemption list of RoHS Directive 2002/95/EC, Item 5: Lead in glass of cathode ray tubes, electronic components and fluorescent tubes.

In light of item 13 in RoHS exemption list of RoHS Directive 2005/747/EC, Item13: Lead and cadmium in optical and filter glass. The three exemptions are being concerned for Opticonnect's transceivers, because Opticonnect's transceivers use glass, which may contain Pb, for components such as lenses, windows, isolators, and other electronic components.

Standard	Description	Nominal Baud Rate	Unit
IEEE 802.3ae-2002	10 GBASE-SR	10.3125	GBd
1200-Mxx-SN-I	10G Fiber Channel	10.51875	GBd

Absolute Maximum Ratings

Rating	Conditions	Symbol	Min	Max	Units
Storage Ambient Temperature Range			-40	+85	°C
Powered case Temperature Range	XFP-SR	T_A	0	+70	°C
	XFP-SR-I		-40	+85	
Operating Relative Humidity		RH	8	80	%
Supply Voltage Range @ 5.0V		V_{C5}	0.5	6.0	V
Supply Voltage Range @ 3.3V		V_{C3}	0.5	3.6	V
Open Drain VCC level		V_O		4.0	V
Static Discharge Voltage on XFI High	HBM human body model per JEDEC JESD22-A114-B			500	V
Static Discharge Voltage excluding XFI High Speed Pins	HBM human body model			2,000	V
Static Discharge Voltage on XFP Module	EN61000-4-2 Criterion B: Air Discharge Direct Contact discharge			15,000 8,000	V V

Any stress beyond the maximum ratings can result in permanent damage. The device specifications are guaranteed only under the recommended operating conditions

Recommend operating condition

Parameter	Conditions	Symbol	Min	Typ	Max	Units
Operating Case Temperature Range	XFP-SR	T_A	0		+70	°C
	XFP-SR-I		-40		+85	
Transceiver total Power Consumption		P_{TOT}		1.5	2.3	W
Power Supply Voltage @ 3.3V		V_{C3}	3.135	3.300	3.465	V
Supply Current	@ V_{C3}	I_{VCC3}		325	600	mA

High Speed Line Characteristics

Parameter	Conditions	Symbol	Min	Typ	Max	Units
Baud Rate nominal			9.95		10.71	Gbd
Baud Rate Tolerance			-100		+100	ppm

High Speed Line Output-DC Characteristics

Parameter	Conditions	Symbol	Min	Typ	Max	Units
Single Ended Output Impedance		$Z_{\mathcal{E}}$	40	50	60	Ω
Differential Output Impedance		$Z_{\mathcal{O}}$	80	100	120	Ω

High Speed Line Output-AC Characteristics

Parameter	Conditions	Symbol	Min	Typ	Max	Units
Differential Output Amplitude		V_{OSPP}	340		850	mV
Output Common Mode		$V_{\mathcal{O}}$	0		3.6	V
Transition Time Low to High		t_r	24			ps
Transition Time High to Low		t_f	24			ps
Differential Output Return Loss	0.05—0.1GHz 0.1—5.5GHz 5.5—12GHz		20 8 See1			dB dB
Common Mode Output Return Loss See 2 Loss ²)	0.1—15GHz	SCC 22	3			dB
Total Peak-to-peak Jitter		D_j			0.34	UI
Output AC Common Mode Voltage					15	mV (RMS)

1. $SDD_{22}(dB) = 8 - 20.66 \log_{10}(f/15.5)$ with f in GHz

2. Common mode reference impedance is 25 Ω . Common mode return loss helps absorb reflection and noise improving EMI.

High Speed Line Input-DC Characteristics

Parameter	Conditions	Symbol	Min	Typ	Max	Units
Differential Output Impedance		R_{IND}	80	100	120	Ω
Input AC Common Mode Input Voltage			0		25	mV (RMS)
Source to Sink DC Potential Difference		$V_{\mathcal{O}}$	0		3.6	V

High Speed Line Input-AC Characteristics

Parameter	Conditions	Symbol	Min	Typ	Max	Units
Differential input Voltage Swing		V_D	120 See 2			mV
Differential Return Loss	0.05—0.1GHz 0.1—5.5GHz 5.5—12GHz	SDD11	20 8 See 1			dB
Common Mode Return Loss	0.1—15GHz	SCC11	3			dB
Total Jitter		T_j			TBD	UI

1. $SDD11(dB)=8-20.66 \log_{10}(f/15.5)$ with f in GHz
2. Beneath this level the signal can't meet the specification

Optical Transmitter

Parameter	Conditions	Symbol	Min	Typ	Max	Units
Nominal Wavelength		λ_{TRP}	840	850	860	nm
Spectral Width		$\Delta\lambda$		0.4	0.45	nm
Operating Range	62.5/125 μ m MMF, 160 MHz*km				26	m
	50/125 μ m MMF, 400 MHz*km				66	
	62.5/125 μ m MMF, 200 MHz*km				33	
	50/125 μ m MMF, 500 MHz*km				82	
	50/125 μ m MMF, 2000MHz*km				300	
Nominal Signalling Speed		f_{OPT}	9.95		10.71	Gbps
Average Launch Power		P_o	-7.3	-2.6	-1	dBm
Extinction Ratio		ER	3.5	5.5		dB
Transmitter and Dispersion Penalty		TDP			3.9	dB
Relative Intensity Noise		RIN			-128	dB/Hz

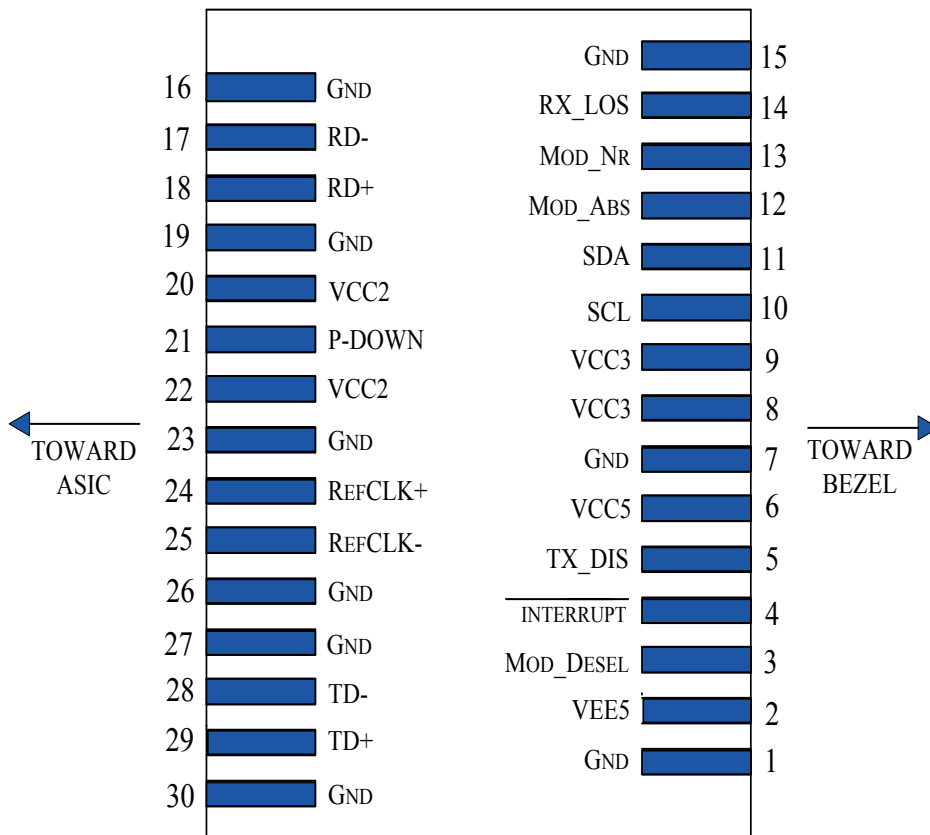
Optical Receiver

Parameter	Conditions	Symbol	Min	Typ	Max	Units
Center Wavelength		λ_C	840	850	860	nm
Receiver Sensitivity	BER 10^{-2} @ $2^3 - 1$	P_N		-13.5	-11.1	dBm
Receiver Sensitivity	in OMA				-11.1	
Stressed Receiver Sensitivity	in OMA	P_N			-7.5	dBm
Saturation Input Power		P_{SAT}	1			dBm

1. With ideal transmitter

Note: The specified characteristics are met within the recommended range of operating conditions and under the default settings of output power and modulation amplitude.. A change in setting of the optical output power influences especially the dynamic behavior of the output signal. Unless otherwise noted typical data are quoted at nominal voltages and +25°C ambient temperature.

Hostboard Connector Pinout



Top View